| ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES International and Pan-American co | ourn. Illinois. All rights reserved u | Inder both This de level p | ocument is a decla arts, the declaratio | ration of the su n encompasses | bstances w s all lower l | ithin the manufacture evel materials for wh | er listed item. hich the manu | Note: if the facturer has | e item is an asser s engineering res | nbly with lower ponsibility. | |
|---|---|----------------------------|--|---|-----------------------------|--|-------------------------------------|---------------------------|---|---------------------------------|--|
| IPC Web Site for Information on I http://www.ipc.org/IPC-175x | IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute | | | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information | | | | | | | |
| Supplier Information | | | | | | | | | | | |
| Company name* | | Unique ID Authority | | | | Response Date* | | | | | |
| onsemi | | | | | | | | 2023-06-08 | | | |
| Contact Name | Title - Contact | | Phone - Con | Phone - Contact* | | | Email - Contact* | | | | |
| Product-Env-Stewards | Product Enviro Compliance | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| Authorized Representative* | horized Representative* Title - Representative | | | Phone - Representative* | | | | Email - Representative* | | | |
| Product-Env-Stewards | | NA | | | | Product-Env-Stewards@onsemi.com | | | | | |
| Requester Item Number Mfr Item | n Number Mfr Item Name | Mfr Item Name | | ate Version | Ma | Manufacturing Site | | ght* | UOM | Unit Type | |
| NCP161 | AFCT350T2G CSP LDO 450mA | A, Active Discharge | 2023-06-08 | | CN | CNG | | 62 | mg | Each | |
| Manufacturing Proccess Information | | | | | i | | · | | | | |
| Terminal Plating / Grid Array Material | Ferminal Base Alloy | J-STD-020 MSL Rating | g Peak P | Peak Process Body Temperature Max 7 | | Max Time at Peak | Temperature Number of Reflow Cycles | | | | |
| Matte Tin (Sn) - annealed CU Alloy 1 | | 1 | 260 | | С | 30 | seconds | 3 | | | |
| Comments | | | | | | | | | | | |
| evel 1 - maximum time at peak temperature during so | Idering is 10-30 seconds | | | | | | | | | | |
| or more information regarding material composition | please refer to page 3 | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | |
|--|--|--|---|---|---|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). | | | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | on above | Supplier Acceptance | * Accepted | | | | | |
| Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | |
| Declaration Signature | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless | cable [E] enter the weigh | , Requester or Supplier) [B It of the substance or the Pl |] select the substa PM concentration | ance category (JIG or Requester) or [F] Optionally enter the positive (- | enter a value (Supplier). [C] selec -) and negative (-) tolerance in per | t the substance (JI cent (Note: percen | G) or enter the substant tolerance values are | nce and CAS (Other). [D] expected to cover a 3 |
|--|---------------------------|--|---|---|---|---|--|---|
| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
| Bump | 0.02444 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 0.0244 | mg |
| Die | 0.21966 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.2197 | mg |
| Protection coat | 0.0059 | mg | | Polyimide | proprietary data | | 0.0059 | mg |
| RDL Sputter | 4.3E-4 | mg | Supplier | Titanium (Ti) | 7440-32-6 | | 0 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.0004 | mg |
| UBM/RDL PCu | 0.01527 | mg | Supplier | Copper (Cu) | 7440-50-8 | | 0.0153 | mg |
| UBM Sputter | 5.0E-4 | mg | Supplier | Titanium (Ti) | 7440-32-6 | | 0.0001 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.0004 | mg |